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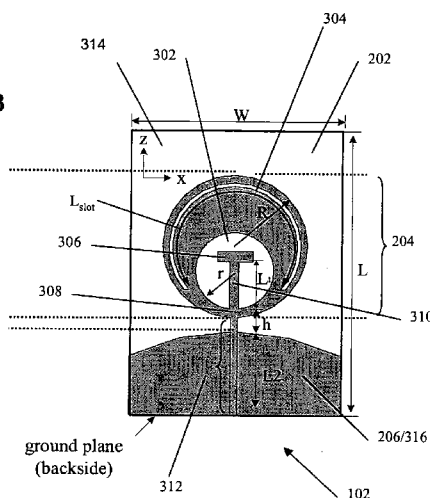
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(54) Title: ANTENNA AND RECEIVER CIRCUIT

FIGURE 3



(57) Abstract: According to one aspect of the invention, there is provided an antenna including: a substrate; a conductive layer formed on a portion of a top surface of the substrate; a first slot formed within the conductive layer; a conductive stub disposed within the first slot, the conductive stub tuned to reject a first frequency band; and a second slot formed within the conductive layer, the second slot tuned to reject a second frequency band.